

In re Application of:
Lawrence C. Lei

Confirmation No.: 4370

Filed: March 3, 2004

For: Apparatus and Method for Vaporizing Solid Precursor for CVD or Atomic Layer Deposition

Group Art Unit: 3742

Examiner: Sang Y. Paik

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

I hereby certify that this correspondence and the documents referred to as attached therein are being facsimile transmitted to the U.S. Patent and Trademark Office to fax number 571-273-8300, or electronically transmitted to the U.S. Patent and Trademark Office via EFS-Web to the attention of Examiner Sang Y. Paik, on the date shown below.

6/7/07
Date

Signature

RESPONSE TO OFFICE ACTION DATED MARCH 19, 2007

In response to the Office Action dated March 19, 2007, having a shortened statutory period for response set to expire on June 19, 2007, please enter this response and reconsider the claims pending in the application for the reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/005191.C1(Y1)/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 5 of this paper.